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					Application Number	101784, 417	
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					First Named Inventor	Minchang Liang	
					Art Unit	2822 1	
					Examiner Name	SOWARD	
Sheet	1	of		1	Attorney Docket Number	A1385	
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lak	A. HOKAZONO et al. "Source/Drain Engineering for Sub-100 nm CMOS Using Selective Epitaxial Growth Technique (c) 2000 IEEE						
	···	A. SAMOILOV et al. "Properties and Applications of Strained Si/SiGe", Applied Materials Inc., April 17, 2002					
		J. ZHANG. et al'.n-Si/l-p-i SiGe/n-Si structure for SiGe microwave power heterojunction bipolar transistor grown by ultra-high-vacuum chemical molecular epitaxy"  Journal of Applied Physics, Vol 86, No. 3, pp. 1463-1466, 1 August 1999 (c) American Institute of Physics					
		M. KUMAR, "A 3-D BiCMOS Technology Using Selective Epitaxial Growth (SEG) and Lateral Solid Phase Epitaxy (LSPE)", (c) 2001 IEEE					
		JM. HARTMANN, "Reduced Pressure - Chemical Vapor Deposition of Si/SiGeC heterostructures for future applications", CEA/LETI Annual Review 2002					
		R. CHAU, "Advanced Depleted-Substrate Transistors: Single-Gate, Double-Gate and Tri-Gate", 2002 International Conference on Solid State Devices and Materials (SSDM 2002), Nagoya, Japen 7/02					
MA	Z. KRIVOKAPIC, "High Performance 25 nm FDSOI Devices with Extremely Thin Silicon Channel"						
AMD, Technology Research Group (6/2003)							
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				, p. 1924			
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